

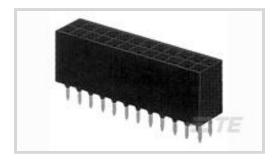
#### AMPMODU | Modu Connector System

TE Internal #: 5-534236-6 PCB Mount Receptacle, Vertical, Board-to-Board, 12 Position, 2.54 mm [.1 in] Centerline, Gold (Au), Through Hole - Solder, Modu Connector System

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles



#### PCB Connector Type: PCB Mount Receptacle

Connector System: Board-to-Board

Number of Positions: 12

Number of Rows: 2

Centerline (Pitch): 2.54 mm [.1 in]

### Features

#### **Product Type Features**

PCB Connector Type

Connector System

Sealable

PCB Mount Receptacle

Board-to-Board

No

Connector & Contact Terminates To	Printed Circuit Board
Connector Product Type	Connector Assembly
Configuration Features	
Stackable	Yes
Number of Positions	12
Number of Rows	2
PCB Mount Orientation	Vertical
Board-to-Board Configuration	Parallel
Electrical Characteristics	
Insulation Resistance	5000 MΩ
Body Features	
Connector Profile	Standard
Primary Product Color	Black
Contact Features	
	150 µin

PCB Mount Receptacle, Vertical, Board-to-Board, 12 Position, 2.54 mm [.1 in] Centerline, Gold (Au), Through Hole - Solder, Modu Connector System



PCB Contact Termination Area Plating Material Finish	Matte
Mating Square Post Dimension	.64 mm[.025 in]
Contact Shape & Form	Square
Contact Protection Type	Closed Entry Housing
Contact Base Material	Phosphor Bronze
PCB Contact Termination Area Plating Material	Tin
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Contact Mating Area Plating Material	Gold (Au)
Contact Type	Socket
Contact Current Rating (Max)	2 A
Termination Features	
Rectangular Termination Post & Tail Width	.69 mm[.027 in]
Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Termination Post & Tail Length	3.04 mm[.12 in]
Termination Method to PCB	Through Hole - Solder
Mechanical Attachment	
Connector Mounting Type	Board Mount
Mating Alignment	Without
PCB Mount Alignment	Without
PCB Mount Retention	Without
Housing Features	
Mating Entry Location	Тор
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Polyester GF
Dimensions	
Connector Height	5.03 mm[.198 in]
Row-to-Row Spacing	2.54 mm[.1 in]
Stack Height	10.92 mm[.43 in]
	1.4 – 2.4 mm[.055 – .094 in]
PCB Thickness (Recommended)	
	L
PCB Thickness (Recommended) Jsage Conditions Housing Temperature Rating	Standard

PCB Mount Receptacle, Vertical, Board-to-Board, 12 Position, 2.54 mm [.1 in] Centerline, Gold (Au), Through Hole - Solder, Modu Connector System



#### **Operation/Application**

Solder Process Feature	Board Standoff
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	37
Packaging Method	Tube
Due du et Commissione	
Product Compliance	
For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025

(247) Candidate List Declared Against: JAN 2025

#### (247)

Does not contain REACH SVHC

#### Halogen Content

Not Low Halogen - contains Br or Cl > 900 ppm.

#### Solder Process Capability

Wave solder capable to 240°C

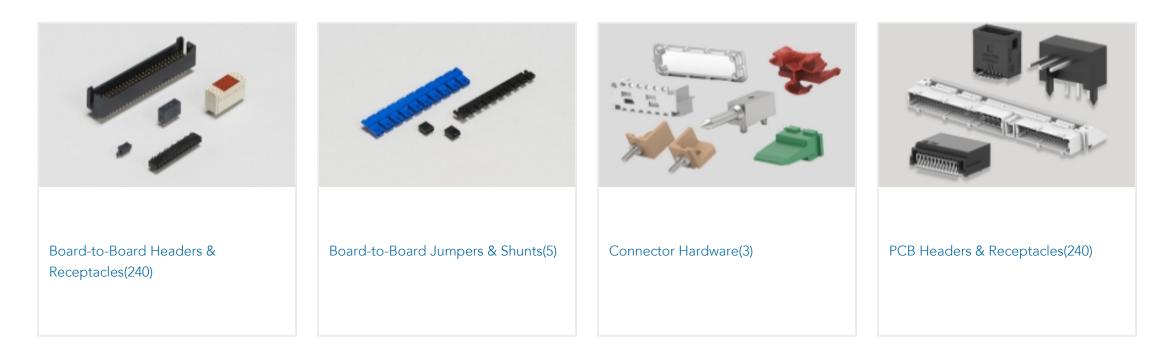
#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# Also in the Series | Modu Connector System

PCB Mount Receptacle, Vertical, Board-to-Board, 12 Position, 2.54 mm [.1 in] Centerline, Gold (Au), Through Hole - Solder, Modu Connector System





# Customers Also Bought









TE Part #5406436-1

LR1 1% 6	K98
----------	-----

## Documents

Product Drawings 12 MODII VRT DR CE 100/120

English

## CAD Files

3D PDF

3D

Customer View Model

ENG\_CVM\_CVM\_5-534236-6\_W.2d\_dxf.zip

English

Customer View Model

ENG\_CVM\_CVM\_5-534236-6\_W.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_5-534236-6\_W.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

**&** For support call+1 800 522 6752

PCB Mount Receptacle, Vertical, Board-to-Board, 12 Position, 2.54 mm [.1 in] Centerline, Gold (Au), Through Hole - Solder, Modu Connector System



Product Specifications Application Specification

English